



Date: December 4, 2024

To,
The Secretary,
BSE Limited
Phiroze Jeejeebhoy Towers,
Dalal Street, Mumbai – 400 001
Fax No.22722037/22723121
Scrip Code: 543971

Dear Sir/Madam,

Sub: Intimation of Board Meeting of Bondada Engineering Limited (“Company”) under Regulation 29(1)(d) of the Securities and Exchange Board of India (Listing Obligations and Disclosure Requirements) Regulations, 2015, as amended (“SEBI LODR Regulations”)

Pursuant to Regulation 29(1) of the SEBI LODR Regulations, we wish to inform you that a meeting of the Board of Directors of the Company is scheduled to be held on **Saturday, December 7, 2024**, *inter alia*, to consider and evaluate the following businesses:

1. Consider and approve a proposal for raising of funds by way of issuance of equity shares or any other eligible securities of the Company, including debentures / non-convertible debt instruments along with warrants / convertible debentures / securities and / or any other equity based instruments, in one or more tranches, through one or more public and/or private offerings, including by way of a preferential issue, qualified institutions placement and/or any other method, as may be decided by the Board, subject to such statutory/regulatory approvals as may be applicable including the approval of shareholders of the Company wherever required.
2. To consider and discuss any other business with the permission of the Chairman.

The aforesaid intimation is also being hosted on the website of the Company i.e., www.bondada.net.

Kindly take the aforementioned submissions on your records.

Thanking you,

For, Bondada Engineering Limited

Sonia Bidlan
CS & Compliance Officer
M.No. A37766

Bondada Engineering Limited
(Formerly known as Bondada Engineering Pvt Ltd)

Regd. Office:
Plot No-37, Ashok Manoj Nagar,
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INDIA

Corporate Office:
BONDADA HOUSE,
C-26, Kushaiguda Industrial Area,
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